U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. ELM-1 Cont. 14	APPLICATION NO. 10/766,557	
JH 2 1 20% 2 INFORMATION DISCLOSURE	APPLICANT Glenn J. Leedy	CONFIRMATION NO. 3092	
STATEMENT BY APPLICANT	FILING DATE January 27, 2004	GROUP 2812	

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F.D	4,702,336	10/27/87	Maeda et al.	180	197		
<del></del>	4,702,936	10/27/87	Seibert et al.	427	<del></del>		
	4,706,166	11/10/87	Go	36			
	4,721,938	01/26/88	Stevenson	338			
	4,761,681	08/02/88	Reid	357			
<del></del>	4,784,721	11/15/88	Holmen et al.	156			
	4,810,673	03/07/89	Freeman	438			
1	4,825,277	04/25/89	Mattox et al.	257			
	4,857,481	08/15/89	Tam et al.	438			
/	4,924,589	05/15/90	Leedy	438			
11	4,940,916	07/10/90	Borel et al.	313			
<del>                                     </del>	Re B14,940,916	11/26/96	Borel et al.	315			
11	4,950,987	08/21/90	Vranish et al.	324			
	4,952,446	08/18/90	Lee et al.	428	1		
	4,954,865	09/04/90	Rokos	257			
	4,957,882	09/18/90	Shinomiya	438			
	4,965,415	10/23/90	Young et al.	200			
	4,966,663	10/30/90	Mauger	205			
	4,994,735	02/19/91	Leedy	324	<del></del>		
	5,008,619	04/16/91	Keogh et al.	324	<del></del>		
	5,010,024	04/23/91	Allen et al.	438		- <del> </del>	
	5,020,219	06/04/91	Leedy	29	846		
	5,034,685	07/23/91	Leedy	324			
7	5,070,026	12/03/91	Greenwald et al.	437		-	
	5,071,510	12/10/91	Findler et al.	156			
	5,098,865	03/24/92	Machado et al.	438			
	5,103,557	04/14/92	Leedy	29	832		
V	5,110,373	05/05/92	Mauger	148			
V	5,111,278	05/05/92	Eichelberger	357			
1	5,116,777	05/26/92	Chan et al.	438			
4-	5,130,894	07/14/92	Miller	361			
THEY	5,132,244	07/21/92	Roy	438			

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FEP	5,151,775	09/29/92	Hadwin	357	80		
1	5,156,909	10/20/92	Henager, Jr. et al.	428	334		
	5,203,731	04/20/93	Zimmerman	445	24		
	5,225,771	07/06/93	Leedy	324	158		
	5,236,118	08/17/93	Bower et al.	228	193		
	5,262,351	11/16/93	Bureau et al.	437	183		
	5,270,261	12/14/93	Bertin et al.	437	209		
1	5,273,940	12/28/93	Sanders	437	209		
	5,274,270	12/28/93	Tuckerman	257	758		
	5,279,865	01/18/94	Chebi et al.	427	574		
	5,284,796	02/08/94	Nakanishi et al.	437	183		
	5,323,035	06/21/94	Leedy	257	48		
	5,324,687	06/28/94	Wojnarowski	437	225		
	5,354,695	10/11/94	Leedy	438	411		
	5,363,021	11/08/94	MacDonald	315	366		
	5,385,909	01/31/95	Nelson et al.	514	291		
	5,385,632	01/31/95	Goossen	156	630		
	5,420,458	05/30/95	Shimoji	257	622		
	5,424,920	06/13/95	Miyake	361	735		
	5,426,072	06/20/95	Finnila	437	208		
-	5,426,363	06/20/95	Akagi et al.	324	239		
	5,432,444	07/11/95	Yasohama et al.	324	240		
	5,432,729	07/11/95	Carson et al.	365	63		
	5,434,500	07/18/95	Hauck et al.	324	67		
	5,451,489	09/19/95	Leedy	430	313		
	5,453,404	09/26/95	Leedy	437	203		
	5,457,879	10/17/95	Gurtler et al.	29	895		
	5,476,813	12/19/95	Naruse	437	132		
	5,489,554	02/06/96	Gates	437	208		
1	5,502,667	03/26/96	Bertin et al.	365	51		
	5,512,397	04/30/96	Leedy	430	30		
HED	5,527,645	06/18/96	Pati et al.	430	5		

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REP	5,529,829	06/25/96	Koskenmaki et al.	428	167	
1	5,534,465	07/09/96	Frye et al.	437	209	
	5,555,212	09/10/96	Toshiaki et al.	365	200	
	5,563,084	10/08/96	Ramm et al.	437	51	
	5,571,741	11/05/96	Leedy	437	51	
	5,580,687	12/03/96	Leedy	430	5	
	5,581,498	12/03/96	Ludwig et al.	365	63	
	5,582,939	12/10/96	Pierrat	430	5	
	5,583,688	12/10/96	Hornbeck	359	291	
7	5,592,007	01/07/97	Leedy	257	347	
	5,592,018	01/07/97	Leedy	257	619	
İ	5,595,933	01/21/97	Heijboer	439	20	
	5,606,186	02/25/97	Noda	257	226	
	5,627,112	05/06/97	Tennant et al.	438	113	
	5,629,137	05/13/97	Leedy	430	313	
	5,633,209	05/27/97	Leedy	435	228	
	5,637,536	06/10/97	Val	438	686	
	5,654,127	08/05/97	Leedy	430	315	
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	5,656,552	08/12/97	Hudak et al.	438	15	
	5,675,185	10/07/97	Chen et al.	257	774	
	5,694,588	12/02/97	Ohara et al.	395	566	
	5,725,995	03/10/98	Leedy	430	315	
	5,750,211	05/12/98	Weise et al.	427	579	
	5,760,478	06/02/98	Bozso et al.	257	777	
	5,773,152	06/30/98	Okonogi	428	446	
	5,786,116	07/28/98	Rolfson	430	5	
	5,793,115	08/11/98	Zavracky et al.	257	777	
	5,831,280	11/03/98	Ray	257	48	
	5,834,334	11/10/98	Leedy	438	107	
	5,840,593	11/24/98	Leedy	438	6	
408	5,856,695	01/05/99	ito et al.	257	370	

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						APPLICANT Glenn J. Leedy		CONFIRMATION N 3092	
	STATEMEN	I BT AP	PLIC			FILING I January	DATE 27, 2004	GROUP 2812	<del></del>
				<u>-</u>				<u></u>	
POP	5,868,949	02/09/	99	Sotokaw	a et al.	216	18		
1	5,869,354	02/09/	99	Leedy		438	110		
	5,870,176	02/09/	99	Sweatt e	t al.	355	53		
.	5,880,010	03/09/	99	Davidso	n	438	455		
	5,882,532	03/16/	99	Field et a	al.	216	2		
	5,902,118	05/11/	99_	Hübner		438	106		
	5,915,167	06/22/	99	Leedy		438	108		
	5,946,559	08/31/	99	Leedy		438	157		
	5,985,693	11/16/	99	Leedy		438	107		
	5,998,069	12/07/	99	Cutter et	al.	430	5		
	6,008,126	12/28/	99	Leedy		438	667		
	6,020,257	02/01/	00	Leedy		438	626		
	6,045,625	04/04/	00	Houston		148	33.3		
	6,084,284	07/04/	00	Adamic,	Jr.	257	506		
	6,097,096	08/01/	00	Gardner	et al.	257	777		
	6,133,640	10/17/	00	Leedy		257	778		
	6,194,245 B1	02/27/	01	Tayanak	<del></del> а	438	57		
	6,197,456 B1	03/06/	01	Aleshin e		430	5		
	6,208,545 B1	03/27/	01	Leedy		365	51		
	6,236,602 B1	05/22/		Patti		365	201		
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V	6,288,561 B1	09/11/	01	Leedy		324	760		
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O I P SUPPLEME	ENTAL INFORMATION DISCLOSURE	APPLICANTS Glenn J. Leedy	CONF. NO. 3092	
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	ENTAL INFORMATION DISCLOSURE	APPLICANTS Glenn J. Leedy	CONF. NO. 3092
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ATTY. DOCKET NO. ELM/001 Cont. 14 10/766,557

APPLICANTS CONF. NO. 3092

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# SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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POP	JP S60-126871	07/06/85	Japan					
RED	JP S63-229862	09/26/88	Japan					
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PRP	JP H01-199476	08/10/89	Japan					
REP.	JP H03-284871	12/16/91	Japan					
PAP	WO 92/03848	03/05/92	PCT					
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REP	WO 01/05366	01/25/01	PCT					

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Substitu	re for form 144	9/PT	0	Complete if known		
				Application Number	10/766,557	
INFO	PRMATION	DISC	CLOSURE	Filing Date	January 27, 2004	
STATEMENT BY APPLICANT				First Named Inventor	Glenn J. Leedy	
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Examiner	Cite	Document Number	Publication Date	Name of Patentee or	Pages, Columns, Lines, Where Relevant Passages or Relevant						
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Initials	No.1	Country Code 1 - Number 2 - Kind Code 3		Applicant of Cited Documents		F				
WA		JP-127816	05-30-1991	Japan						
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All References Have Been Considered: Examiner

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				Application Number	10/766,557 (Conf. No.: 3092)	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				Filing Date	January 27, 2004	
				First Named Inventor	Glenn J. Leedy	
				Art Unit	2812	
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initials	No.1	Country Code <sup>1</sup> - Number <sup>2</sup> - Kind Code <sup>3</sup>	MM-DD-YYYY	Applicant of Cited Documents		<b>™</b>					
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Examiner initials	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-Issue number(s), publisher, city and/or country where published	т <sup>6</sup>
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All References Have Been Considered:	
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Substitu	ite for form 144	19/PT	0	Complete if known		
				Application Number	10/766,557 (Conf. No.: 3092)	
INFO	RMATION	DISC	CLOSURE	Filing Date	January 27, 2004	
STATEMENT BY APPLICANT				First Named Inventor	Glenn J. Leedy	
3.7.				Art Unit	2812	
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Sheet	1	of	1	Attorney Docket Number	ELM-1 CONT.14	

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Applicant's unique citation designation number (optional). See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. Inter Office that issued the document, by the two-letter code (MIPO Standard ST.3). For Japanese patent documents, the Indication of the year of the reign of the Emperor must precede the serial number of the patent document. Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. Applicant is to place a check mark benefit for inclined transfer the serial forms. a check mark here if English language translation is attached.

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				Application Number	10/766,557 (Conf. No.: 3092)		
INFO	DRMATION	DISC	CLOSURE	Filing Date	January 27, 2004		
STATEMENT BY APPLICANT				First Named Inventor	Glenn J. Leedy		
UIA			LIGAN	Art Unit	2812		
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Sheet 1 of 1		Attorney Docket Number	ELM-1 CONT.14				

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-		•		Application Number	10/766,557	(Conf. No. 3092)		
11	NFORMATION	N DI	SCLOSURE	Filing Date	January 27, 2004			
l s	TATEMENT I	BY A	APPLICANT	First Named Inventor	Glenn J. Leedy			
				Art Unit	2812			
	(Use as many sh	eets as	s necessary)	Examiner Name	Amir Zarabian			
Sheet	1	of	3	Attorney Docket Number	ELM-1 Cont.1	4		

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Subs	stitute for form 1449A/B	PTO		Complete If Known			
	34.000 107 107111 14407404			Application Number	10/766,557	(Conf. No. 3092)	
เพ	IFORMATIC	n disc	CLOSURE	Filing Date	January 27, 2004		
	TATEMENT			First Named Inventor	Glenn J. Leedy		
				Art Unit	2812		
	(Use as many	sheets as nec	essary)	Examiner Name	Amir Zarabian		
Sheet	2	of	3	Attorney Docket Number	ELM-1 Cont.1	4	

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				Application Number	10/766,557	(Conf. No. 3092)	
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Sī	TATEMENT	BY A	APPLICANT	First Named Inventor			
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(Use as many sheets as necessary)			Examiner Name	Amir Zarabian			
Sheet	3	of	3	Attorney Docket Number	ELM-1 Cont.1	4	

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